

ID	R <sub>DS</sub> (ON)(Typ)	VDSS
20A	160mΩ	650V

#### Applications:

- Switch Mode Power Supply(SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)
- AC-DC Switching Power Supply

#### Features:

- Fast switching speed
- 100% avalanche tested
- Improved dv/dt capability

#### **Ordering Information**

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U s	HS	EACH	HF

Part Number	Package	Marking	Packing	Qty.
RS65R190T	T0-220	RS65R190T	Tube	50 PCS

#### Absolute Maximun Ratings Tc= 25°C unless otherwise specified

Symbol	Parameter	RS65R190T	Units
VDSS	Drain-to-Source Voltage	650	V
ID	Continuous Drain Current TC=25℃	20	
ID	Continuous Drain Current TC=100°C	13	A
IDM	Pulsed Drain Current (Note*1)	60	
PD	Power Dissipation	134	W
VGS	Gate- to- Source Voltage	±30	V
EAS	EAS L=10mH,VDS= 50V, RG = 25 $\Omega$ , TC=25 $^{\circ}$ C		mJ
dv/dt	MOSFET dv/ dt ruggedness VDS = 0400V	50	V/ns
dv/dt	Reverse diode dv/dt VDS = 0400V, Tj = 25℃, ISD≤ID	15	V/ns
	Maximum Temperature for Soldering	300	
TL TPKG	Leads at 0.063in(1.6mm)from Case for 10 seconds Package Body for 10 seconds	260	°C
TJ and TSTG	Operating Junction and Storage Temperature Range	-55 to 150	

\* Drain Current Limited by Maximum Junction Temperature

Caution: Stresses greater than those listed in the" Absolute Maximum Ratings" Table may cause permanent damage to the device.



## **Thermal Resistance**

Symbol	Parameter	RS65R190T	Units	Test Conditions	
				Drain lead soldered to water cooled	
RθJC	Junction-to-Case	0.93		heatsink, PD adjusted for a peak	
			°C/W	junction temperature of + 1 5 0 $^\circ \! \mathbb{C}$	
DOIA	Junction-to-	(25		1 auhia fa at abamban fuas ain	
RθJA	Ambient	62.5		1 cubic foot chamber,free air.	

#### **OFF Characteristics** TJ= $25^{\circ}$ C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BVDSS	Drain- to- source Breakdown Voltage	650			V	VGS=0V,ID=250µA
IDSS	Drain- to- Source Leakage Current			1	μA	VDS=650V,VGS=0 V
	Gate- to- Source Forward Leakage			100		VGS=30V,VDS=0V
IGSS	Gate- to- Source Reverse Leakage			-100	nA	VGS=-30V ,VDS=0 V

# **ON Characteristics** TJ=25°C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
RDS(on)	Static Drain- to- Source On- Resistance(Note*2)		160	190	mΩ	VGS=10V,ID=10A
VGS(TH)	Gate Threshold Voltage	2		4	V	VGS=VDS,ID=250µ A

## Resistive Switching Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
td(ON)	Turn- on Delay Time		23			
trise	Rise Time		35		- 6	VDS=325V
td(OFF)	Turn- OFF Delay Time		113		nS	ID=20A RG=25Ω
tfall	Fall Time		28			



Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Ciss	Input Capacitance		1490			VGS=0V
Coss	Output Capacitance		101		pF	VDS=50V
Crss	Reverse Transfer Capacitance		2.3			f=1.0MHz
Qg	Total Gate Charge		36			VDS=520V
Qgs	Gate- to- Source Charge		7.2		nC	ID=20A
Qgd	Gate-to-Drain(" Miller") Charge		16			VGS=10V

# **Dynamic Characteristics** Essentially independent of operating temperature

#### **Source- Drain Diode Characteristics**

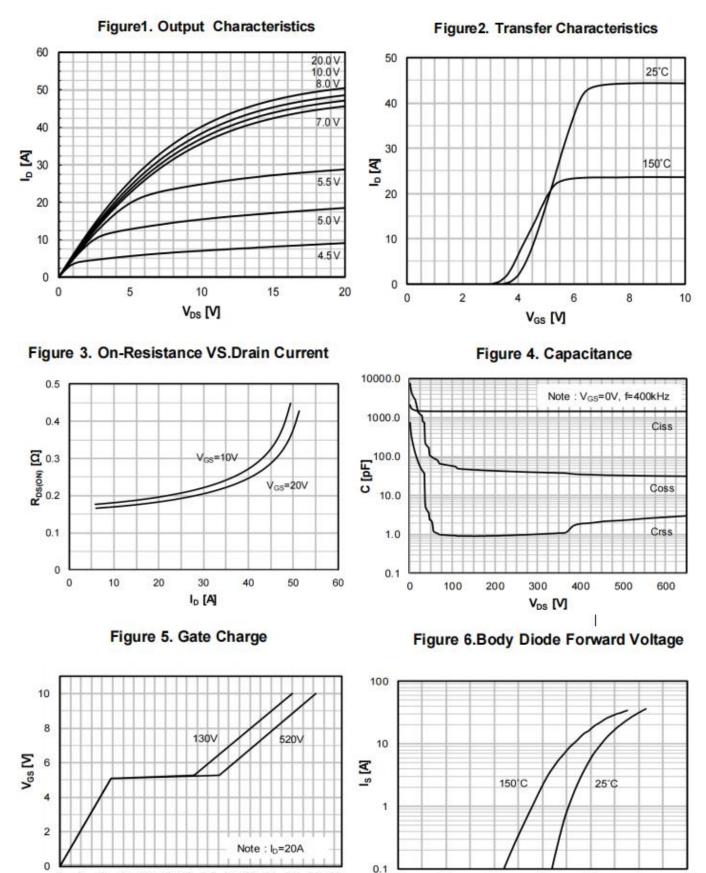
Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
IS	Continuous Source Current			20	А	Integral pn- diode
ISM	Maximum Pulsed Current			60	А	in MOSFET
VSD	Diode Forward Voltage			1.4	V	IS=20A,VGS=0V
trr	Reverse Recovery Time		347		nS	VR=100V
Qrr	Reverse Recovery Charge		5		μC	IS=20A,di/dt=100A /µs

#### Notes:

- \* 1. Repetitive rating, pulse width limited by maximum junction temperature.
- \* 2. Pulse Test: Pulse width  $\leq$  300µs, Duty Cycle  $\leq$  2%



#### **Typical Feature Curve**



0 3 6 9

12 15

Q<sub>G</sub> [nC]

18 21 24 27 30 33 36 39

0

0.2

0.4

0.6

V<sub>SD</sub> [V]

0.8

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1

1.2



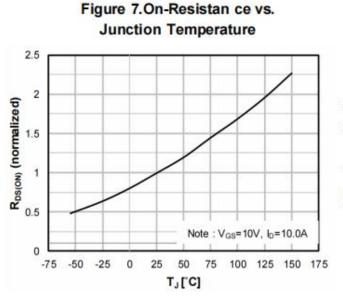


Figure 8.Bearkdown Voltage vs.

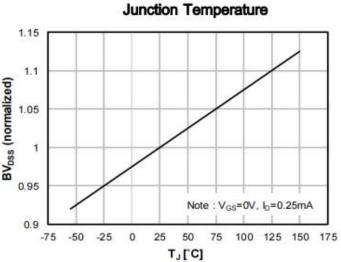
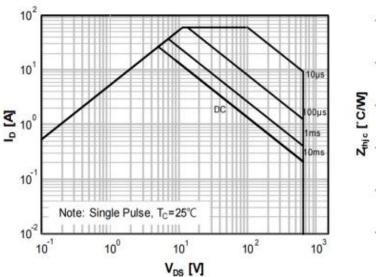
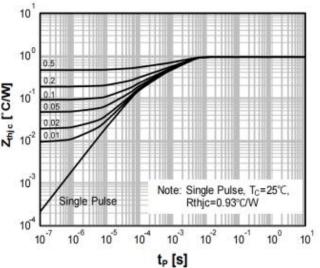


Figure 9.Safe operation area

Figure 10.Transient Thermal Impedance

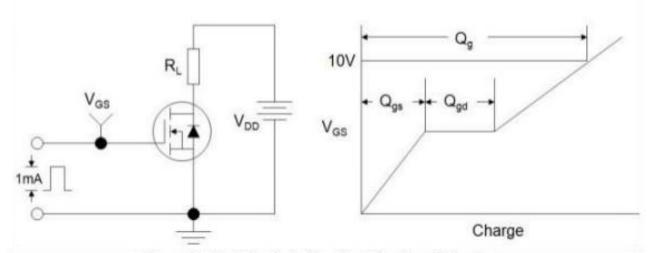






## Test Circuits and Waveforms







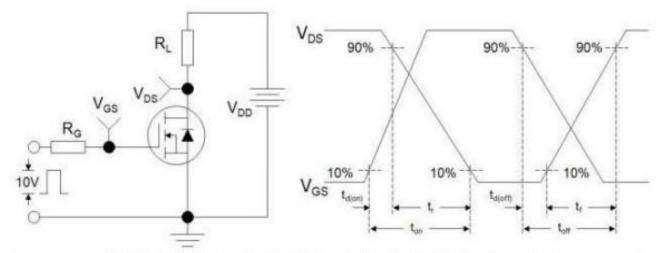
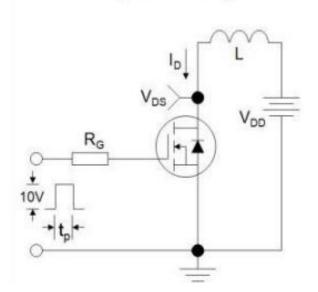
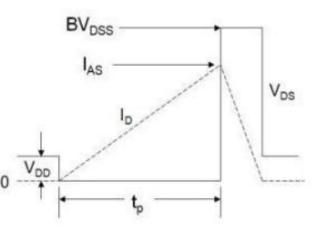


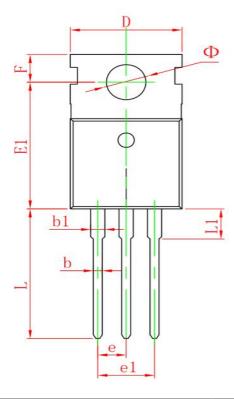
Figure C: Unclamped Inductive Switching Test Circuit and Waveform

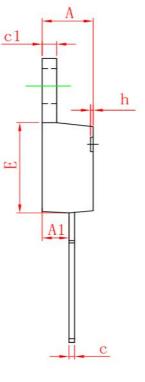


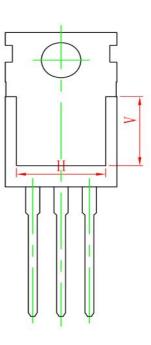




# Package outline drawing(TO-220 Unit: mm)







Symbol	Dimensions	In Millimeters	Dimension	s in inches
Symbol	Min.	Max.	Min.	Max.
A	4.400	4.600	0.173	0.181
A1	2.250	2.550	0.089	0.100
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
С	0.330	0.650	0.013	0.026
c1	1.200	1.400	0.047	0.055
D	9.910	10.250	0.390	0.404
E	8.950	9.750	0.352	0.384
E1	12.650	13.050	0.498	0.514
е	2.540	TYP.	0.100	TYP.
e1	4.980	5.180	0.196	0.204
F	2.650	2.950	0.104	0.116
Н	7.900	8.100	0.311	0.319
h	0.000	0.300	0.000	0.012
L	12.900	13.400	0.508	0.528
L1	2.850	3.250	0.112	0.128
V	6.900 REF.		0.276 REF.	
Ф	3.400	3.800	0.134	0.150



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